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FQD8P10TM-F085

100V P-Channel MOSFET

General Description

These P-Channel enhancement mode power field effect transistors are produced using ON Semiconductor's proprietary, planar stripe, DMOS technology.

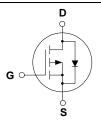
This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for low voltage applications such as audio amplifier, high efficiency switching DC/DC converters, and DC motor control.

Features

- -6.6A, -100V, $R_{DS(on)} = 0.53\Omega$ @ $V_{GS} = -10$ V
- Low gate charge (typical 12 nC)
- · Low Crss (typical 30 pF)
- · Fast switching
- 100% avalanche tested
- · Improved dv/dt capability
- Qualified to AEC Q101
- · RoHS Compliant







Absolute Maximum Ratings T_C = 25°C unless otherwise noted

| Symbol | Parameter | | Ratings | Units | |
|-----------------------------------|---|----------|-------------|-------|--|
| V _{DSS} | Drain-Source Voltage | | -100 | V | |
| I _D | Drain Current - Continuous (T _C = 25°C) | | -6.6 | А | |
| | - Continuous (T _C = 100 | 0°C) | -4.2 | Α | |
| I _{DM} | Drain Current - Pulsed | (Note 1) | -26.4 | А | |
| V _{GSS} | Gate-Source Voltage | | ± 30 | V | |
| E _{AS} | Single Pulsed Avalanche Energy | (Note 2) | 150 | mJ | |
| I _{AR} | Avalanche Current (Note 1) | | -6.6 | Α | |
| E _{AR} | Repetitive Avalanche Energy | (Note 1) | 4.4 | mJ | |
| dv/dt | Peak Diode Recovery dv/dt | (Note 3) | -6.0 | V/ns | |
| P_{D} | Power Dissipation (T _A = 25°C) * | | 2.5 | W | |
| | Power Dissipation (T _C = 25°C) | | 44 | W | |
| | - Derate above 25°C | | 0.35 | W/°C | |
| T _J , T _{STG} | Operating and Storage Temperature Range | | -55 to +150 | °C | |
| T _L | Maximum lead temperature for soldering purposes, 1/8" from case for 5 seconds | | 300 | °C | |

Thermal Characteristics

| Symbol | Parameter | Тур | Max | Units |
|-----------------|---|-----|------|-------|
| $R_{\theta JC}$ | Thermal Resistance, Junction-to-Case | | 2.84 | °C/W |
| $R_{\theta JA}$ | Thermal Resistance, Junction-to-Ambient * | | 50 | °C/W |
| $R_{\theta JA}$ | Thermal Resistance, Junction-to-Ambient | | 110 | °C/W |

* When mounted on the minimum pad size recommended (PCB Mount)

| Symbol | Parameter | Test Conditions | Min | Тур | Max | Units |
|--|--|---|------|------------------|-----------------------------|----------------|
| Off Cha | aracteristics | | | | | |
| BV _{DSS} | Drain-Source Breakdown Voltage | $V_{GS} = 0 \text{ V}, I_D = -250 \mu\text{A}$ | -100 | | | V |
| ΔBV _{DSS} / ΔT _J | Breakdown Voltage Temperature Coefficient | I_D = -250 μA, Referenced to 25°C | | -0.1 | | V/°C |
| I _{DSS} | Zoro Cata Valtaga Drain Current | V _{DS} = -100 V, V _{GS} = 0 V | | | -1 | μА |
| | Zero Gate Voltage Drain Current | V _{DS} = -80 V, T _C = 125°C | | | -10 | μΑ |
| I _{GSSF} | Gate-Body Leakage Current, Forward | V _{GS} = -30 V, V _{DS} = 0 V | | | -100 | nA |
| I _{GSSR} | Gate-Body Leakage Current, Reverse | V _{GS} = 30 V, V _{DS} = 0 V | | | 100 | nA |
| On Cha | aracteristics | | | | | |
| V _{GS(th)} | Gate Threshold Voltage | V _{DS} = V _{GS} , I _D = -250 μA | -2.0 | | -4.0 | V |
| R _{DS(on)} | Static Drain-Source On-Resistance | V _{GS} = -10 V, I _D = -3.3 A | | 0.41 | 0.53 | Ω |
| g _{FS} | Forward Transconductance | $V_{DS} = -40 \text{ V}, I_D = -3.3 \text{ A}$ (Note 4) | | 4.1 | | S |
| C _{oss} | Output Capacitance Reverse Transfer Capacitance | f = 1.0 MHz | | 120 30 | 155 40 | pF pF |
| C _{rss} | Reverse Transfer Capacitance | | | 30 | 40 | pF |
| Switchi | ing Characteristics | | | | | |
| t _{d(on)} | Turn-On Delay Time | V _{DD} = -50 V, I _D = -8.0 A, | | 11 | 30 | ns |
| t _r | Turn-On Rise Time | $R_G = 25 \Omega$ | | 110 | 230 | ns |
| + | Turn-Off Delay Time | 1.0 =0 == | | 20 | 50 | ns |
| t _{d(off)} | | | | | | |
| . , | Turn-Off Fall Time | (Note 4, 5) | | 35 | 80 | ns |
| | , , , , , , , , , , , , , , , , , , , | (Note 4, 5) V _{DS} = -80 V, I _D = -8.0 A, | | 35 12 | 80 15 | ns nC |
| t _f Q _g | Turn-Off Fall Time | , , , , | | | | |
| t _f | Turn-Off Fall Time Total Gate Charge | V _{DS} = -80 V, I _D = -8.0 A, | | 12 | 15 | nC |
| t _f Q _g Q _{gs} Q _{gd} | Turn-Off Fall Time Total Gate Charge Gate-Source Charge Gate-Drain Charge | $V_{DS} = -80 \text{ V}, I_{D} = -8.0 \text{ A},$ $V_{GS} = -10 \text{ V}$ (Note 4, 5) | | 12 3.0 | 15 | nC nC |
| t _f Q _g Q _{gs} Q _{gd} Drain-S | Turn-Off Fall Time Total Gate Charge Gate-Source Charge Gate-Drain Charge Source Diode Characteristics and | V_{DS} = -80 V, I_{D} = -8.0 A, V_{GS} = -10 V (Note 4, 5) | | 12 3.0 6.4 | 15 | nC nC |
| $egin{array}{l} \mathbf{t_f} & \\ \mathbf{Q_g} & \\ \mathbf{Q_{gs}} & \\ \mathbf{Q_{gd}} & \\ & \\ \textbf{Drain-S} & \\ \mathbf{I_S} & \\ \end{array}$ | Turn-Off Fall Time Total Gate Charge Gate-Source Charge Gate-Drain Charge Source Diode Characteristics and Maximum Continuous Drain-Source Diode | V _{DS} = -80 V, I _D = -8.0 A, V _{GS} = -10 V (Note 4, 5) Maximum Ratings de Forward Current | | 12 3.0 | 15 | nC nC nC |
| $egin{array}{l} \mathbf{t_f} & \\ \mathbf{Q_g} & \\ \mathbf{Q_{gs}} & \\ \mathbf{Q_{gd}} & \\ \hline egin{array}{c} \mathbf{Drain-S} & \\ \mathbf{I_S} & \\ \mathbf{I_{SM}} & \\ \hline \end{array}$ | Turn-Off Fall Time Total Gate Charge Gate-Source Charge Gate-Drain Charge Source Diode Characteristics and Maximum Continuous Drain-Source Diode Faxing Maximum Pulsed Drain-Source Diode Faxing Times The Police Faxing Times Total Times Time | V _{DS} = -80 V, I _D = -8.0 A, V _{GS} = -10 V (Note 4, 5) And Maximum Ratings ode Forward Current Forward Current | | 12 3.0 6.4 | 15 -6.6 -26.4 | nC nC |
| t _f Q _g Q _{gs} Q _{gd} Drain-S | Turn-Off Fall Time Total Gate Charge Gate-Source Charge Gate-Drain Charge Source Diode Characteristics and Maximum Continuous Drain-Source Diode | V _{DS} = -80 V, I _D = -8.0 A, V _{GS} = -10 V (Note 4, 5) Maximum Ratings de Forward Current | | 12 3.0 6.4 | 15 | nC nC nC |

- **Notes:** 1. Repetitive Rating : Pulse width limited by maximum junction temperature 2. L = 5.2mH, I_{AS} = -6.6A, V_{DD} = -25V, R_G = 25 Ω , Starting T_J = 25°C 3. I_{SD} \leq -8.0A, di/dt \leq 300A/µs, V_{DD} \leq BV_{DSS}, Starting T_J = 25°C 4. Pulse Test : Pulse width \leq 300µs, Duty cycle \leq 2% 5. Essentially independent of operating temperature

Typical Characteristics

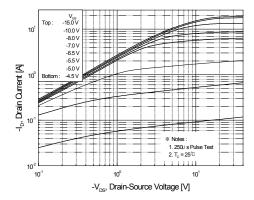


Figure 1. On-Region Characteristics

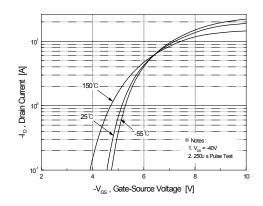


Figure 2. Transfer Characteristics

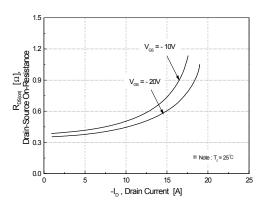


Figure 3. On-Resistance Variation vs. Drain Current and Gate Voltage

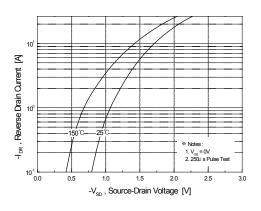


Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperature

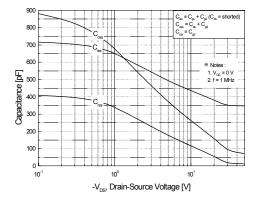


Figure 5. Capacitance Characteristics

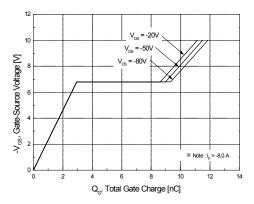
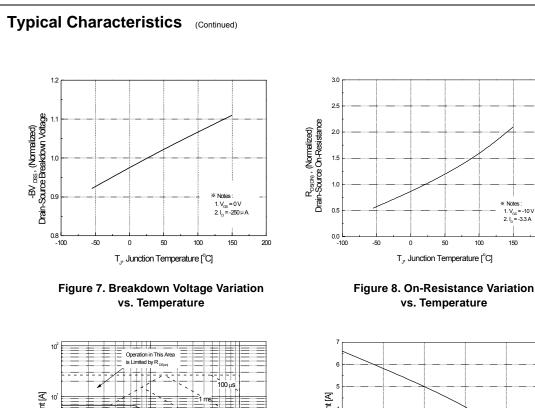


Figure 6. Gate Charge Characteristics

150



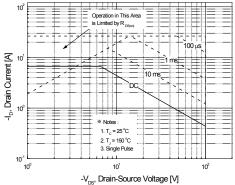


Figure 9. Maximum Safe Operating Area

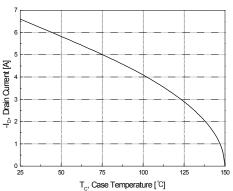


Figure 10. Maximum Drain Current vs. Case Temperature

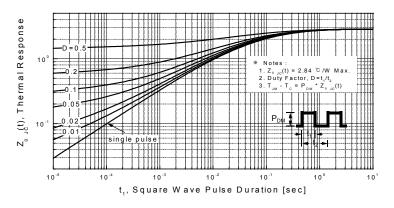
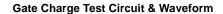
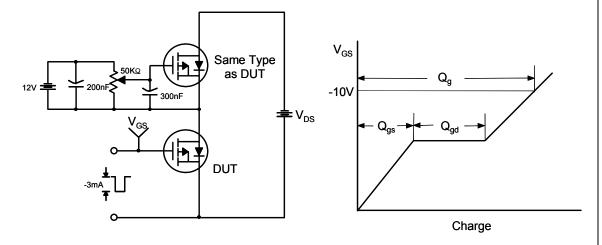
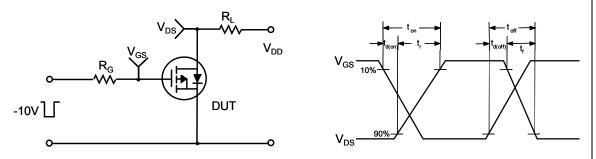


Figure 11. Transient Thermal Response Curve

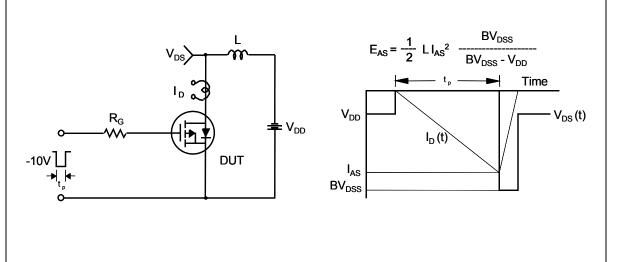




Resistive Switching Test Circuit & Waveforms

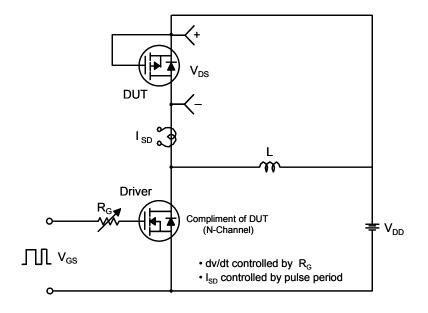


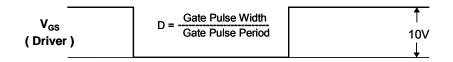
Unclamped Inductive Switching Test Circuit & Waveforms

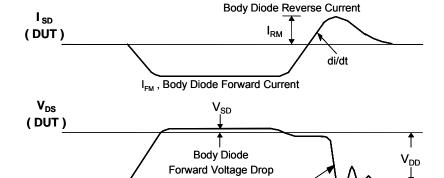


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Peak Diode Recovery dv/dt Test Circuit & Waveforms







Body Diode Recovery dv/dt

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